



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

5 Applicant: Chih-Ning Wu Examiner: Umez Eronini, Lynette T  
Filing Date: 07/16/2001 Art Unit: 1765  
App. No.: 09/682,054 Docket No.: NAUP0374USA

10 Title: EXTRUSION-FREE WET CLEANING PROCESS FOR COPPER-DUAL  
DAMASCENE STRUCTURES

To: Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

15 Subject: Response to the Office action dated 09/23/2003 and the  
Advisory action dated 01/02/2004

20 Dear Sir or Madame:

**INTRODUCTORY COMMENTS**

OK to  
Enter N.N.  
2/22/04  
25 Please accept this reply as a replacement for the previous reply faxed November 21,  
2003. The extension fee is submitted herein. In this reply, claims 8-19 are cancelled  
without prejudice or disclaimer to the subject matter thereof to put the application in  
condition for allowance. The applicant reserves the right to file continuation applications  
for the cancelled claims.

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